







Specifications	<div><div> ENG_SS_114-5044_E1.tif</div><div>English</div></div> <div><div>Application Specification</div><div><div> ENG_SS_114-5044_E1.pdf</div><div>English</div></div><div><div>Product Specification</div><div><div> ENG_SS_108-57062_E.pdf</div><div>English</div></div><div><div>Qualification Test Report</div><div><div> ENG_SS_501-57070_C.pdf</div><div>English</div></div></div></div></div>
Product Environmental Compliance	<div><div>TE Material Declaration</div><div><div> ENG_PC_MD_1734035-2_L.pdf</div><div>English</div></div></div>
Agency Approvals	<div><div>UL Report</div><div><div> ENG_AAD_UL_E28476_20010309__A.pdf</div><div>English</div></div></div>
Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.	
Product Type Features	<div>USB Connector Type : B</div> <div>USB Version : 2.0</div> <div>Connector & Housing Type : Receptacle</div> <div>Connector System : Cable-to-Board</div> <div>Connector & Contact Terminates To : Printed Circuit Board</div> <div>Integral Locking Latch : Without</div> <div>LED : Without</div> <div>Product Type : Connector</div>
Configuration Features	<div>Number of Ports : 1</div> <div>Number of Positions : 5</div>
Body Features	<div>Connector Profile : Mini</div> <div>Offset (mm): 0</div> <div>Shell Plating Material : Nickel</div>
Contact Features	<div>Contact Current Rating (Max) (A): 1</div> <div>Contact Mating Area Plating Thickness : .76 μm [29.92 μin]</div> <div>Contact Mating Area Plating Material : Gold Flash over Palladium Nickel</div>
Termination Features	<div>Termination Method to Printed Circuit Board : Surface Mount</div>

Mechanical Attachment	PCB Mount Location : Top PCB Connector Seating : Flush PCB Mount Retention Type : SMT Hold-Down Connector Mounting Type : Board Mount Locating Posts : With Locking Feature : With
Housing Features	Body Orientation : Right Angle Centerline (Pitch) : .8 mm [.031 in] Housing Color : Black Housing Material : PA 9T GF
Dimensions	PCB Thickness (Recommended) : 1.57 mm [.062 in] Tail Length : 1.15 mm [.045 in]
Usage Conditions	Soldering Temperature (Max) : 260 °C [500 °F] Mating Cycles (Max) : 5000 Operating Temperature Range (°C): -40 – 85, -40 – 85 Operating Temperature Range (°F): -40 – 185, -40 – 185
Operation/Application	Halogen Free : No Circuit Application : Power & Signal
Industry Standards	UL Flammability Rating : UL 94V-0 Industry Standard : USB 2.0 Test Identification (TID) : 60001202 Moisture Sensitivity Level : 1
Packaging Features	Packaging Method : Tape & Reel Packaging Quantity : 700
Statement of Compliance	Statement of Compliance pdf